

### **Excellent Integrated System Limited**

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Kingbright DA08-11CGKWA

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



### 20.3mm (0.8INCH) DUAL DIGIT NUMERIC DISPLAY

The Green source color devices are made with AlGaInP on

Part Number: DA08-11CGKWA Green

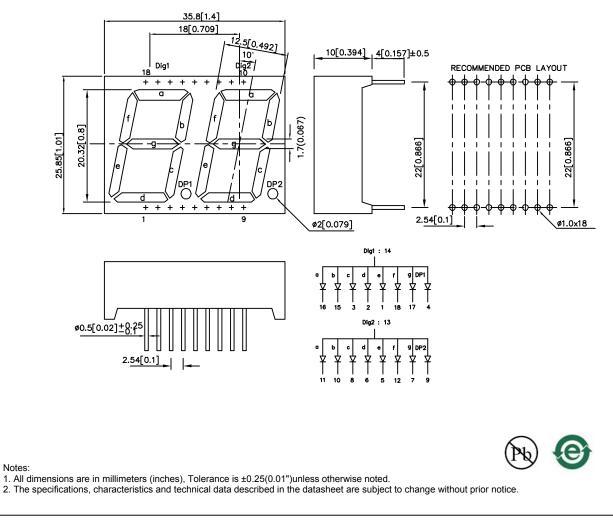
GaAs substrate Light Emitting Diode.

Description

### Features

- 0.8 inch digit height.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Two digit package simplifies alignments & assembly.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

### Package Dimensions& Internal Circuit Diagram





### **Selection Guide**

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description	
			Min.	Тур.	• • • • • •	
DA08-11CGKWA	Green (AlGaInP)	White Diffused	14000	38000	Common Anode ,Rt. Hand Decimal.	
			*5600	*12000		

Notes:

1. Luminous intensity/ luminous Flux: +/-15%.

\*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	I⊧=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	I⊧=20mA
IR	Reverse Current	Green		10	uA	VR=5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			
Lead Solder Temperature[2]	260°C For 3-5 Seconds			

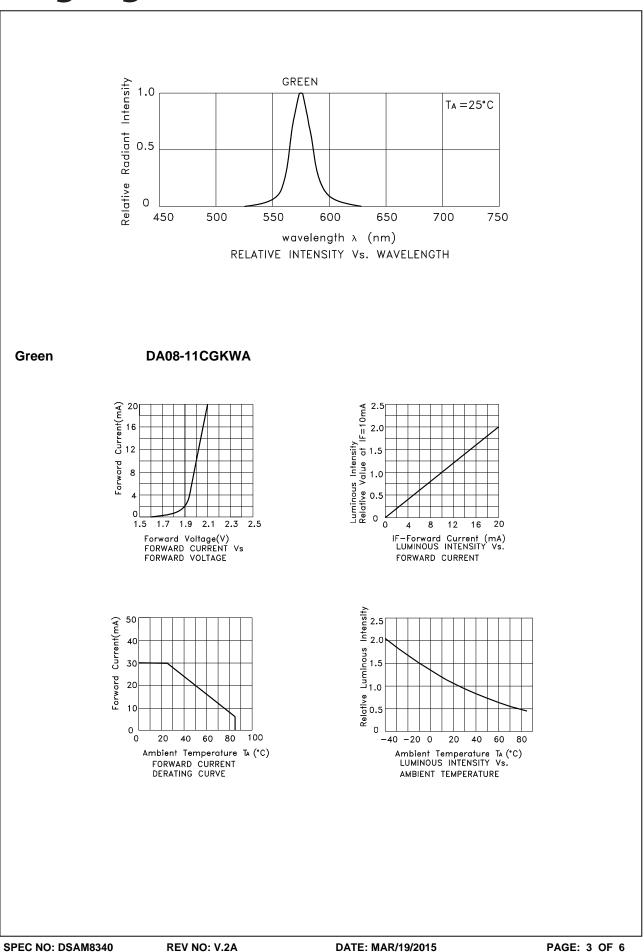
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

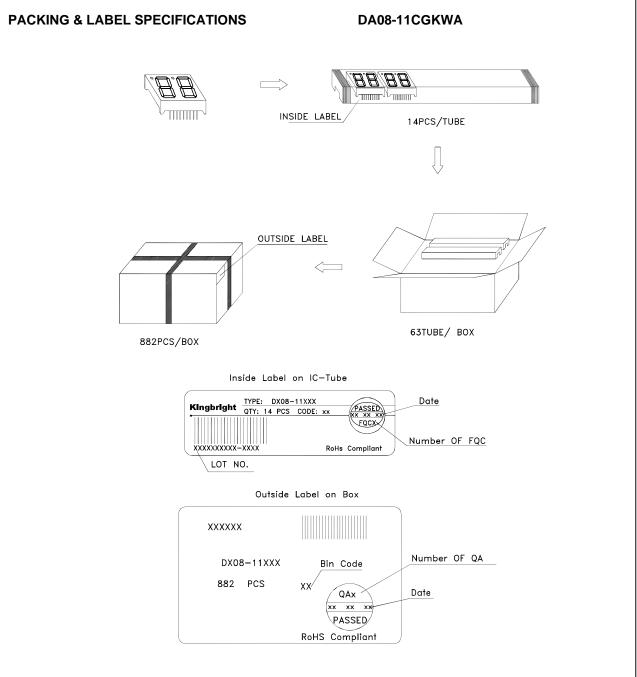
2. 2mm below package base.

<sup>3.</sup> Wavelength value is traceable to the CIE127-2007 compliant national standards.









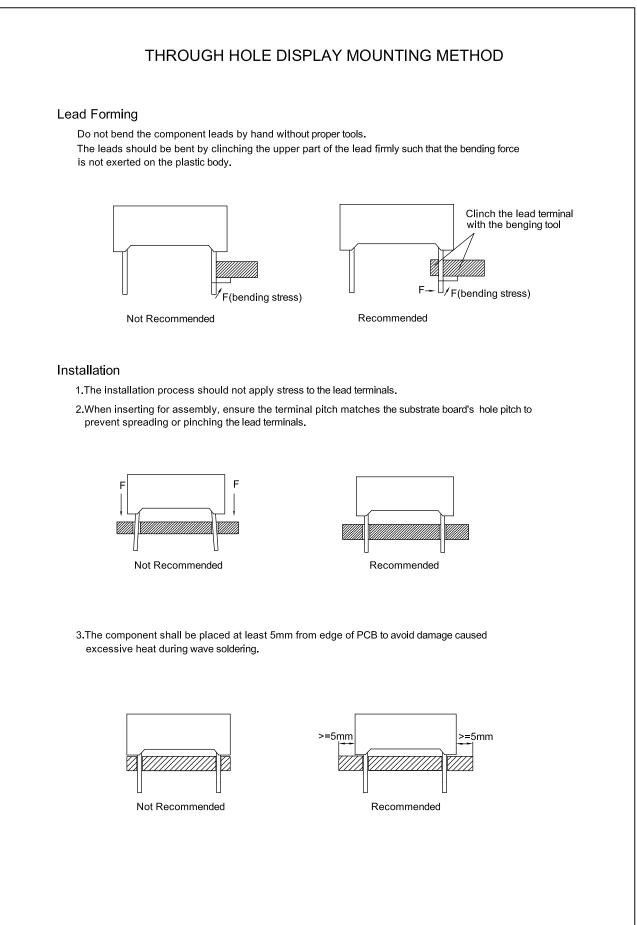
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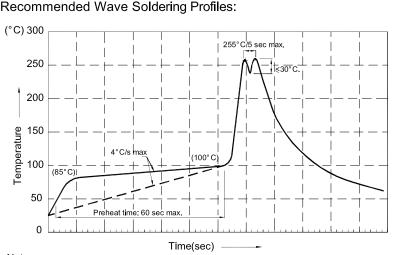
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#### Notes:

- Recommend pre-heat temperature of 105° C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260° C
- 2 Peak wave soldering temperature between 245° C  $\sim$  255° C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above  $85^\circ\text{C}.$
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.
- 7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

#### Soldering General Notes:

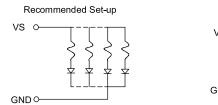
- 1. Through-hole displays are incompatible with reflow soldering.
- 2.If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

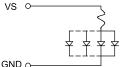
#### CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only.
- Do not use harsh organic solvents for cleaning because they may damage the plastic parts .
- 3. The cleaning process should take place at room temperature and the devices should not be washed for more than one minute.
- 4.When water is used in the cleaning process, immediately remove excess moisture from the component with forced-air drying afterwards.

#### **CIRCUIT DESIGN NOTES**

- 1.Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
- 2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.





invalid Set-up

- 3. The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- 4. The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- 5. Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.